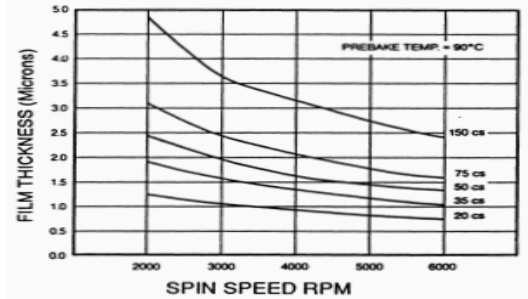


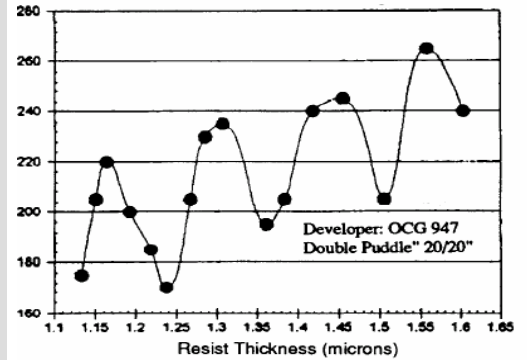
825 Series

825 is a production viable system compatible with broadband, g-line and i-line exposure tools.

- Compatible with MIF and MIC developers
- 825 is a single solvent resist formulation cast in ethyl 3ethoxypropionate
- Thermally stable to >130°C
- Stripping 825 can be accomplished with all standard wet or dry techniques. It's high thermal stability allows effective stripping even after harsh dry etch and ion implant processes
- 825 can be developed in spray and immersion processes using OCG 934 developer 3:2.



Exposure (E²) vs. Film Thickness (g-line)
E-zero (milliseconds)



Film Thickness Loss vs Prebake Temperature

